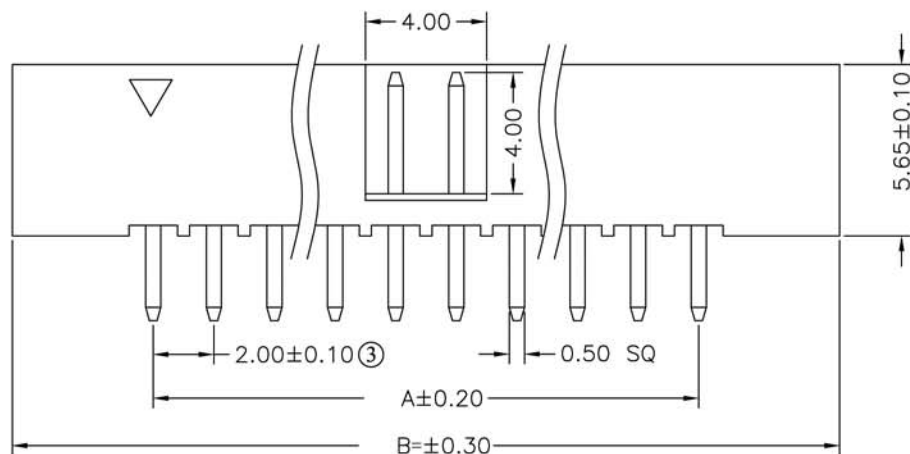
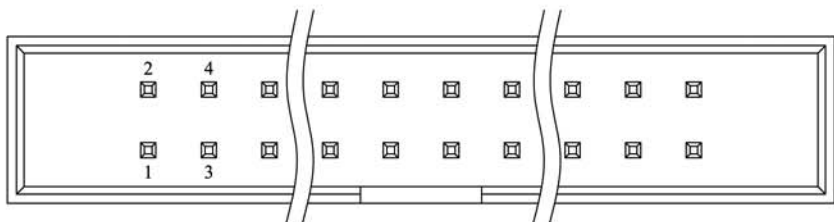
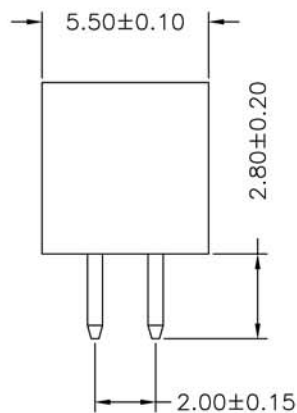


Recommended PCB Layout

No. of PINS	Dimension Information		No. of PINS	Dimension Information	
	A	B		A	B
06	4.00	13.34	36	34.00	43.34
08	6.00	15.34	38	36.00	45.34
10	8.00	17.34	40	38.00	47.34
12	10.00	19.34	42	40.00	49.34
14	12.00	21.34	44	42.00	51.34
16	14.00	23.34	46	44.00	53.34
18	16.00	25.34	48	46.00	55.34
20	18.00	27.34	50	48.00	57.34
22	20.00	29.34	52	50.00	59.34
24	22.00	31.34	54	52.00	61.34
26	24.00	33.34	56	54.00	63.34
28	26.00	35.34	58	56.00	65.34
30	28.00	37.34	60	58.00	67.34
32	30.00	39.34	62	60.00	69.34
34	32.00	41.34	64	62.00	71.34



SPECIFICATIONS:

Current Rating: 1.5AMP
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩ Min
 Withstand Voltage: 500V AC/minute
 Voltage rating data: 250V AC/rms 60HZ
 Operation Temperature: -40°C to +105°C
 Reflow Condition: 260±5°C, 5s

Contact: Brass

plating: See plating options

Insulator: High Temperature Thermoplastic

UL94V-0 Rated

Standard: PA6T+30%G.F

Note:

Recommended PCB thickness is 1.6mm~2.0mm

T823 X XX XX XX 00 X EU

Box Header
w/o Latch, 2.0pitch

Housing Color:
0: Grey
1: Black

No of Positions:
06: 6 positions

64: 64 positions

Plating Options:
A1: Gold Flash over 50u"Ni
A2: 15u" Gold over 50u"Ni
A3: 30u" Gold over 50u"Ni
A4: Gold flash/Tin over 50u"Ni
S1: 15u" Gold/Tin over 50u"Ni
SN: Full Tin over 50u"Ni

EU: RoHS
Compliant

Variation code
C=STD,PBT
2.8mm Pin tail
H=high Temp
Nylon 6T
L=LCP

Direction
S1=ST DIP
R1=R/A DIP

TOLERANCE (mm)	APPROVALS	DATE	TITLE 2.0 Box header Dip Stright Type			AMPHENOL	
X. ±0.3	DRAWN Stephane	2010/FEB/8				Amphenol European Design Center	
X.X ±0.2	CHECKED Rob	2010/FEB/8					
X.XX ±0.15	APPROVED Rob	2010/FEB/8					
UNLESS OTHERWISE SPECIFIED		UNIT : mm	SIZE : A4	DRAWING N°	T823-XXXXXS100HEU		REV. : B
			Scale N.A.		Sheet 1 of 1		